

| Course Code | Course Title                                   | L | T | P | C |
|-------------|--|---|---|---|---|
| 1152EC221   | ELECTROMAGNETIC INTERFERENCE AND COMPATIBILITY | 2 | 0 | 2 | 3 |

**a) Course Category**

Program elective

**b) Preamble**

This course provides basic information on the different electromagnetic Interference problems occurring in Intersystem, their possible mitigation techniques in Electronic design, also to understand EMI sources, EMI problems, their solutions at PCB level, as well as to understand sub system level design and to measure the emission, immunity level from different systems to couple with the prescribed EMC standards.

**c) Prerequisite**

Electromagnetic Fields

**d) Related Courses**

Waveguides& Antennas

**e) Course educational objectives**

Introduce the concepts of electromagnetic interference and electromagnetic interference compatibility

Study the electromagnetic interference coupling principles

Study the electromagnetic interference control techniques

Learn electromagnetic compatibility design of PCBS

Discuss electromagnetic interference measurements and standards

**f) Course Outcomes**

Upon the successful completion of the course, students will be able to:

| CO Nos. | Course Outcomes  | Knowledge Level<br>(Based on Revised Bloom's Taxonomy) |
|---------|--|--|
| CO1     | Describe the concept of EMI / EMC related to product design & development.                       | K2   |
| CO2     | Analyze the different EM coupling principles and its impact on performance of electronic system. | K3   |
| CO3     | Analyze the electromagnetic interference, highlighting the                                       | K3   |

|     |   |    |
|-----|---|----|
|     | concepts of both susceptibility and immunity.   |    |
| CO4 | Analyze various EM compatibility issues with regard to the design of PCBs and ways to improve the overall system performance. | K3 |
| CO5 | Describe various EM radiation measurement techniques and the present leading edge industry standards in different countries   | K2 |

| g)  | Correlation of COs with POs |     |     |     |     |     |     |     |     |      |      |      |      |      |
|-----|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|------|
|     | PO1                         | PO2 | PO3 | PO4 | PO5 | PO6 | PO7 | PO8 | PO9 | PO10 | PO11 | PO12 | PSO1 | PSO2 |
| CO1 | H                           | H   | M   | L   | L   | -   | -   | L   | -   | -    | -    | L    | -    | -    |
| CO2 | H                           | H   | M   | -   | -   | -   | -   | -   | -   | -    | -    | -    | -    | -    |
| CO3 | -                           | H   | -   | -   | M   | -   | -   | -   | -   | -    | -    | -    | L    | -    |
| CO4 | M                           | H   | -   | -   | L   | -   | -   | -   | -   | -    | -    | -    | L    | -    |
| CO5 | M                           | -   | -   | L   | L   | L   | -   | -   | -   | L    | L    | -    | L    | -    |

## h) Course Content

### UNIT I EMI/EMC CONCEPTS 9

EMI-EMC definitions and Units of Parameters; Sources and Victim of EMI; Conducted and Radiated EMI Emission and Susceptibility; Transient EMI, ESD; Radiation Hazards.

### UNIT II EMI COUPLING PRINCIPLES 9

Conducted, Radiated and Transient coupling; Common ground impedance coupling; Common mode and Ground loop coupling; Differential mode coupling; Near field cable to Cable coupling, Cross talk; Field to Cable coupling; Power mains and Power supply coupling.

### UNIT III EMI CONTROL TECHNIQUES 9

Shielding Material- Characteristics of Filters-Impedance and Lumped element filters-Filter installation and Evaluation; Grounding, Bonding, Isolation transformer, Transient suppressors, EMC Gaskets.

### UNIT IV EMC DESIGN OF PCBs 9

EMI Suppression Cables-Devices-Transient protection hybrid circuits; PCB Trace impedance; Routing; - Electromagnetic Pulse-Noise from Relays and Switches, Power distribution decoupling; Zoning; Grounding

### UNIT V EMI MEASUREMENTS AND STANDARDS 9

Open area test site; TEM cell; EMI Test Shielded chamber and Shielded Ferrite Lined anechoic chamber; Tx /Rx Antennas, Sensors, Injectors / Couplers, and Coupling factors; EMI Rx and Spectrum analyzer; Civilian Standards-CISPR, FCC, IEC, EN; Military Standards –Frequency Allocation and Spectrum Utilization -

Comparisons.

### List of experiments

| S. No | Practical Exercises (15 Hours)  | COs     |
|-------|---|---------|
| 1.    | Concept of Self-Induction Board   | CO1     |
| 2.    | Concept of Lenz Law   | CO1     |
| 3.    | EMI effects on Co-axial Cable   | CO2,CO3 |
| 4.    | Concept of Cross Talk Basic Phenomena   | CO2,CO4 |
| 5.    | EMI effects on Cross Talk problem   | CO2,CO4 |
| 6.    | EMI effects on Inductance and Capacitance with various VIAs and                             | CO4     |
| 7.    | EMI effects on Inductance and Capacitance with Radial and SMD components                    | CO4     |
| 8.    | EMI effects on Ground Bounce for Symmetric IC Power Pins                                    | CO4     |
| 9.    | EMI effects on Ground Bounce with Difference Between Symmetric and Asymmetric IC Power Pins | CO4     |

**Total 60 Hours**

#### i) Learning Resources

##### Text Books

1. V.P.Kodali, "Engineering EMC Principles, Measurements and Technologies", IEEE Press, New York, 1996.
2. Henry W. Ott., "Noise Reduction Techniques in Electronic Systems", A Wiley Inter Science Publications, John Wiley and Sons, New York, 1988.

##### Reference Books

1. Bernhard Keiser, "Principles of Electromagnetic Compatibility", 3<sup>rd</sup> Ed, Artech House, Norwood, 1986
2. C.R. Paul, "Introduction to Electromagnetic Compatibility", John Wiley and Sons, Inc, 1992.

##### Online Resources

1. <http://www.metlabs.com/blog/emc/electromagnetic-compatibility-compliance-engineers-use-these-emc-resources/>
2. <http://www.intertek.com/emc/>